

# 74LVT244A-Q100; 74LVTH244A-Q100

3.3 V octal buffer/line driver; 3-state

Rev. 1 — 22 April 2013

Product data sheet

## 1. General description

The 74LVT244A-Q100; 74LVTH244A-Q100 is a high-performance BiCMOS product designed for  $V_{CC}$  operation at 3.3 V.

This device is an octal buffer that is ideal for driving bus lines. The device features two output enables ( $\overline{OE}$ ,  $\overline{OE}$ ), each controlling four of the 3-state outputs.

This product has been qualified to the Automotive Electronics Council (AEC) standard Q100 (Grade 3) and is suitable for use in automotive applications.

## 2. Features and benefits

- Automotive product qualification in accordance with AEC-Q100 (Grade 3)
  - ◆ Specified from  $-40^{\circ}\text{C}$  to  $+85^{\circ}\text{C}$
- Octal bus interface
- 3-state buffers
- Output capability: +64 mA and -32 mA
- TTL input and output switching levels
- Input and output interface capability to systems at 5 V supply
- Bus hold data inputs eliminate need for external pull-up resistors to hold unused inputs
- Live insertion and extraction permitted
- Power-up 3-state
- No bus current loading when output is tied to 5 V bus
- Latch-up protection
  - ◆ JESD78 Class II exceeds 500 mA
- ESD protection:
  - ◆ MIL-STD-883, method 3015 exceeds 2000 V
  - ◆ HBM JESD22-A114F exceeds 2000 V
  - ◆ MM JESD22-A115-A exceeds 200 V ( $C = 200 \text{ pF}$ ,  $R = 0 \Omega$ )

**nexperia**

### 3. Ordering information

Table 1. Ordering information

Type number	Package	Temperature range	Name	Description	Version
74LVT244AD-Q100	SO20	–40 °C to +85 °C		plastic small outline package; 20 leads; body width 7.5 mm	SOT163-1
74LVTH244AD-Q100					
74LVT244APW-Q100	TSSOP20	–40 °C to +85 °C		plastic thin shrink small outline package; 20 leads; body width 4.4 mm	SOT360-1
74LVTH244APW-Q100					
74LVT244ABQ-Q100	DHVQFN20	–40 °C to +85 °C		plastic dual in-line compatible thermal enhanced very thin quad flat package; no leads; 20 terminals; body 2.5 × 4.5 × 0.85 mm	SOT764-1
74LVTH244ABQ-Q100					

### 4. Functional diagram

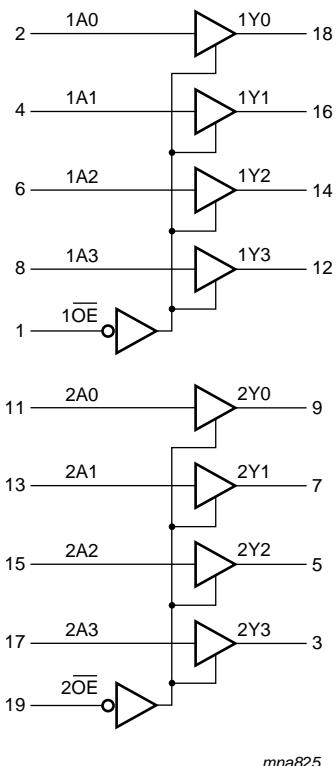


Fig 1. Logic symbol

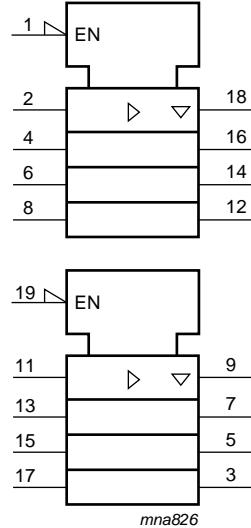


Fig 2. IEC logic symbol

## 5. Pinning information

### 5.1 Pinning

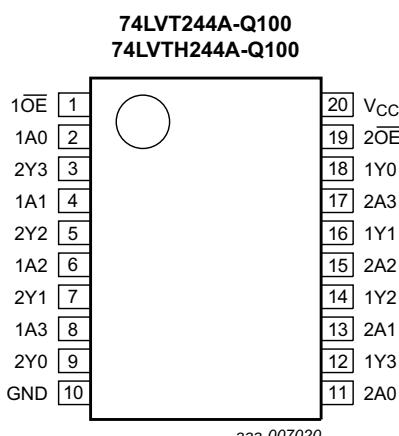
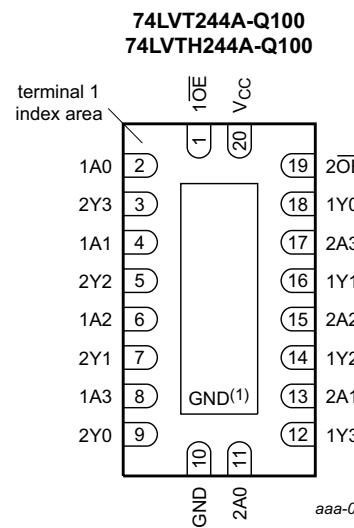


Fig 3. Pin configuration for SO20 and TSSOP20



Transparent top view

(1) This is not a supply pin. The substrate is attached to this pad using conductive die attach material. There is no electrical or mechanical requirement to solder this pad. However, if it is soldered, the solder land should remain floating or be connected to GND.

Fig 4. Pin configuration for DHVQFN20

### 5.2 Pin description

Table 2. Pin description

Symbol	Pin	Description
1OE, 2OE	1, 19	output enable input (active low)
1A0, 1A1, 1A2, 1A3	2, 4, 6, 8	data input
2Y0, 2Y1, 2Y2, 2Y3	9, 7, 5, 3	data output
GND	10	ground (0 V)
2A0, 2A1, 2A2, 2A3	11, 13, 15, 17	data input
1Y0, 1Y1, 1Y2, 1Y3,	18, 16, 14, 12	data output
VCC	20	supply voltage

## 6. Functional description

### 6.1 Function table

Table 3. Function table [1]

Control	Input	Output
nOE	nAn	nYn
L	L	L
	H	H
H	X	Z

[1] H = HIGH voltage level; L = LOW voltage level; X = don't care; Z = high-impedance OFF-state.

## 7. Limiting values

Table 4. Limiting values

In accordance with the Absolute Maximum Rating System (IEC 60134). Voltages are referenced to GND (ground = 0 V).

Symbol	Parameter	Conditions	Min	Max	Unit
V <sub>CC</sub>	supply voltage		-0.5	+4.6	V
V <sub>I</sub>	input voltage		[1] -0.5	+7.0	V
V <sub>O</sub>	output voltage	output in OFF-state or HIGH-state	[1] -0.5	+7.0	V
I <sub>IK</sub>	input clamping current	V <sub>I</sub> < 0 V	-	-50	mA
I <sub>OK</sub>	output clamping current	V <sub>O</sub> < 0 V	-	-50	mA
I <sub>O</sub>	output current	output in LOW-state	-	128	mA
		output in HIGH-state	-	-64	mA
T <sub>stg</sub>	storage temperature		-65	+150	°C
T <sub>j</sub>	junction temperature		[2] -	150	°C
P <sub>tot</sub>	total power dissipation	T <sub>amb</sub> = -40 to +85 °C	[3]	500	mW

[1] The input and output negative voltage ratings may be exceeded if the input and output clamp current ratings are observed.

[2] The performance capability of a high-performance integrated circuit in conjunction with its thermal environment can create junction temperatures which are detrimental to reliability.

[3] For SO20 package: above 70 °C derate linearly with 8 mW/K.

For TSSOP20 package: above 60 °C derate linearly with 5.5 mW/K.

For DHVQFN20 package: above 60 °C derate linearly with 4.5 mW/K.

## 8. Recommended operating conditions

Table 5. Operating conditions

Symbol	Parameter	Conditions	Min	Typ	Max	Unit
V <sub>CC</sub>	supply voltage		2.7	-	3.6	V
V <sub>I</sub>	input voltage		0	-	5.5	V
I <sub>OH</sub>	HIGH-level output current		-	-	-32	mA

Table 5. Operating conditions ...continued

Symbol	Parameter	Conditions	Min	Typ	Max	Unit
$I_{OL}$	LOW-level output current	none	-	-	32	mA
		current duty cycle $\leq 50\%$ ; $f_i \geq 1$ kHz	-	-	64	mA
$T_{amb}$	ambient temperature	in free-air	-40	-	+85	°C
$\Delta t/\Delta V$	input transition rise and fall rate	outputs enabled	-	-	10	ns/V

## 9. Static characteristics

Table 6. Static characteristics

At recommended operating conditions; voltages are referenced to GND (ground = 0 V).

Symbol	Parameter	Conditions	Min	Typ	Max	Unit
$T_{amb} = -40$ °C to +85 °C [1]						
$V_{IK}$	input clamping voltage	$V_{CC} = 2.7$ V; $I_{IK} = -18$ mA	-1.2	-0.9	-	V
$V_{IH}$	HIGH-level input voltage		2.0	-	-	V
$V_{IL}$	LOW-level input voltage		-	-	0.8	V
$V_{OH}$	HIGH-level output voltage	$V_{CC} = 2.7$ V to 3.6 V; $I_{OH} = -100$ $\mu$ A	$V_{CC} - 0.2$	$V_{CC} - 0.1$	-	V
		$V_{CC} = 2.7$ V to 3.6 V; $I_{OH} = -8$ mA	2.4	2.5	-	V
		$V_{CC} = 3.0$ V; $I_{OH} = -32$ mA	2.0	2.2	-	V
$V_{OL}$	LOW-level output voltage	$V_{CC} = 2.7$ V; $I_{OL} = 100$ $\mu$ A	-	0.1	0.2	V
		$V_{CC} = 2.7$ V; $I_{OL} = 24$ mA	-	0.3	0.5	V
		$V_{CC} = 3.0$ V; $I_{OL} = 16$ mA	-	0.25	0.4	V
		$V_{CC} = 3.0$ V; $I_{OL} = 32$ mA	-	0.3	0.5	V
		$V_{CC} = 3.0$ V; $I_{OL} = 64$ mA	-	0.4	0.55	V
$I_I$	input leakage current	all input pins				
		$V_{CC} = 0$ V or 3.6 V; $V_I = 5.5$ V	-	0.1	10	$\mu$ A
		control pins				
		$V_{CC} = 3.6$ V; $V_I = V_{CC}$ or GND	-	$\pm 0.1$	$\pm 1$	$\mu$ A
		data pins [2]				
$I_{OFF}$	power-off leakage current	$V_{CC} = 0$ V; $V_I$ or $V_O = 0$ V to 4.5 V	-	1	$\pm 100$	$\mu$ A
		$V_{CC} = 3$ V; $V_I = 0.8$ V	[3]	75	150	-
$I_{BHL}$	bus hold LOW current	$V_{CC} = 3$ V; $V_I = 2.0$ V	-	-150	-75	$\mu$ A
$I_{BHH}$	bus hold HIGH current					
$I_{BHLO}$	bus hold LOW overdrive current	nAn input; $V_{CC} = 0$ V to 3.6 V; $V_I = 3.6$ V	500	-	-	$\mu$ A
$I_{BHHO}$	bus hold HIGH overdrive current	nAn input; $V_{CC} = 0$ V to 3.6 V; $V_I = 3.6$ V	-	-	-500	$\mu$ A
$I_{LO}$	output leakage current	nYn output in HIGH-state when $V_O > V_{CC}$ ; $V_O = 5.5$ V; $V_{CC} = 3.0$ V	-	60	125	$\mu$ A
$I_{O(pu/pd)}$	power-up/power-down output current	$V_{CC} \leq 1.2$ V; $V_O = 0.5$ V to $V_{CC}$ ; $V_I = \text{GND}$ or $V_{CC}$ ; nOE = don't care	[4]	-	$\pm 1$	$\pm 100$ $\mu$ A

**Table 6. Static characteristics ...continued**

At recommended operating conditions; voltages are referenced to GND (ground = 0 V).

Symbol	Parameter	Conditions	Min	Typ	Max	Unit
I <sub>OZ</sub>	OFF-state output current	V <sub>CC</sub> = 3.6 V; V <sub>I</sub> = V <sub>IH</sub> or V <sub>IL</sub>				
		V <sub>O</sub> = 3.0 V	-	1	5	μA
		V <sub>O</sub> = 0.5 V	-5	-1	-	μA
I <sub>CC</sub>	supply current	V <sub>CC</sub> = 3.6 V; V <sub>I</sub> = GND or V <sub>CC</sub> ;				
		I <sub>O</sub> = 0 A				
		output HIGH	-	0.13	0.19	mA
		output LOW	-	3	12	mA
ΔI <sub>CC</sub>	additional supply current	outputs disabled	[5]	-	0.13	0.19 mA
		per input pin; V <sub>CC</sub> = 3.0 V to 3.6 V;	[6]	-	0.1	0.2 mA
		one input at V <sub>CC</sub> – 0.6 V and other inputs at V <sub>CC</sub> or GND				
C <sub>I</sub>	input capacitance	V <sub>I</sub> = 0 V or 3.0 V	-	4	-	pF
C <sub>O</sub>	output capacitance	outputs disabled; V <sub>O</sub> = 0 V or 3.0 V	-	8	-	pF

[1] All typical values are at T<sub>amb</sub> = 25 °C.[2] Unused pins at V<sub>CC</sub> or GND.

[3] This is the bus hold overdrive current required to force the input to the opposite logic state.

[4] This parameter is valid for any V<sub>CC</sub> between 0 V and 1.2 V with a transition time of up to 10 ms. From V<sub>CC</sub> = 1.2 V to V<sub>CC</sub> = 3.3 V ± 0.3 V a transition time of 100 μs is permitted. This parameter is valid for T<sub>amb</sub> = 25 °C only.[5] I<sub>CC</sub> is measured with outputs pulled to V<sub>CC</sub> or GND.[6] This is the increase in supply current for each input at the specified voltage level other than V<sub>CC</sub> or GND.

## 10. Dynamic characteristics

**Table 7. Dynamic characteristics**Voltages are referenced to GND (ground = 0 V); for test circuit see [Figure 7](#).

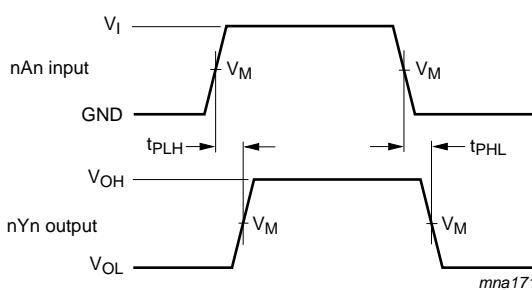
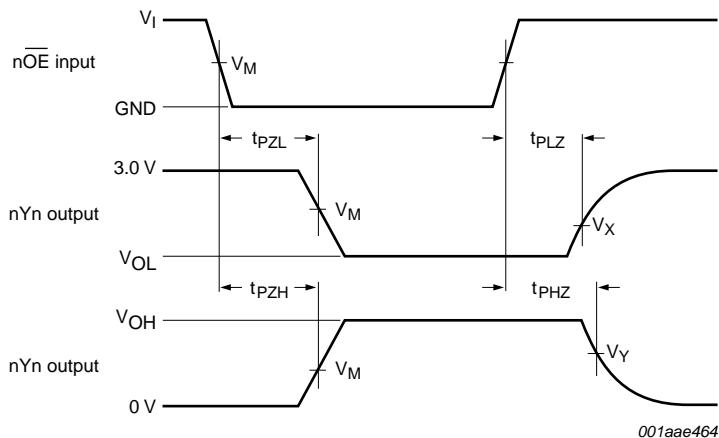
Symbol	Parameter	Conditions	Min	Typ	Max	Unit
<b>T<sub>amb</sub> = –40 °C to +85 °C [1]</b>						
t <sub>PLH</sub>	LOW to HIGH propagation delay	nAn to nYn; see <a href="#">Figure 5</a>				
		V <sub>CC</sub> = 2.7 V	-	-	5.0	ns
		V <sub>CC</sub> = 3.0 V to 3.6 V	1	2.5	4.1	ns
t <sub>PHL</sub>	HIGH to LOW propagation delay	nAn to nYn; see <a href="#">Figure 5</a>				
		V <sub>CC</sub> = 2.7 V	-	-	5.1	ns
		V <sub>CC</sub> = 3.0 V to 3.6 V	1	2.6	4.1	ns
t <sub>PZH</sub>	OFF-state to HIGH propagation delay	see <a href="#">Figure 6</a>				
		V <sub>CC</sub> = 2.7 V	-	-	6.3	ns
		V <sub>CC</sub> = 3.0 V to 3.6 V	1	3.2	5.2	ns
t <sub>PZL</sub>	OFF-state to LOW propagation delay	see <a href="#">Figure 6</a>				
		V <sub>CC</sub> = 2.7 V	-	-	6.7	ns
		V <sub>CC</sub> = 3.0 V to 3.6 V	1.1	3.1	5.2	ns
t <sub>PHZ</sub>	HIGH to OFF-state propagation delay	see <a href="#">Figure 6</a>				
		V <sub>CC</sub> = 2.7 V	-	-	6.3	ns
		V <sub>CC</sub> = 3.0 V to 3.6 V	1.9	3.3	5.6	ns

**Table 7. Dynamic characteristics ...continued**Voltages are referenced to GND (ground = 0 V); for test circuit see [Figure 7](#).

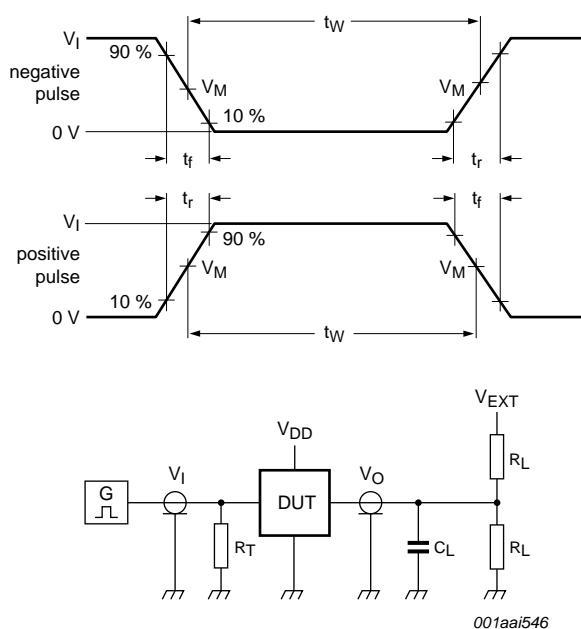
Symbol	Parameter	Conditions	Min	Typ	Max	Unit
$t_{PLZ}$	LOW to OFF-state propagation delay	see <a href="#">Figure 6</a>				
		$V_{CC} = 2.7 \text{ V}$	-	-	5.6	ns
		$V_{CC} = 3.0 \text{ V to } 3.6 \text{ V}$	1.8	3.3	5.1	ns

[1] All typical values are at  $V_{CC} = 3.3 \text{ V}$  and  $T_{amb} = 25^\circ\text{C}$ .

## 11. Waveforms

Measurement points are given in [Table 8](#). $V_{OL}$  and  $V_{OH}$  are typical voltage output levels that occur with the output load.**Fig 5. Propagation delay input (nAn) to output (nYn) propagation delays**Measurement points are given in [Table 8](#). $V_{OL}$  and  $V_{OH}$  are typical voltage output levels that occur with the output load.**Fig 6. 3-state output enable and disable times****Table 8. Measurement points**

Input	Output		
$V_M$ 1.5 V	$V_M$ 1.5 V	$V_X$ $V_{OL} + 0.3 \text{ V}$	$V_Y$ $V_{OH} - 0.3 \text{ V}$



Test data is given in [Table 9](#).

Definitions test circuit:

$R_L$  = Load resistance.

$C_L$  = Load capacitance including jig and probe capacitance.

$R_T$  = Termination resistance should be equal to output impedance  $Z_0$  of the pulse generator.

$V_{EXT}$  = Test voltage for switching times.

**Fig 7. Test circuit for measuring switching times**

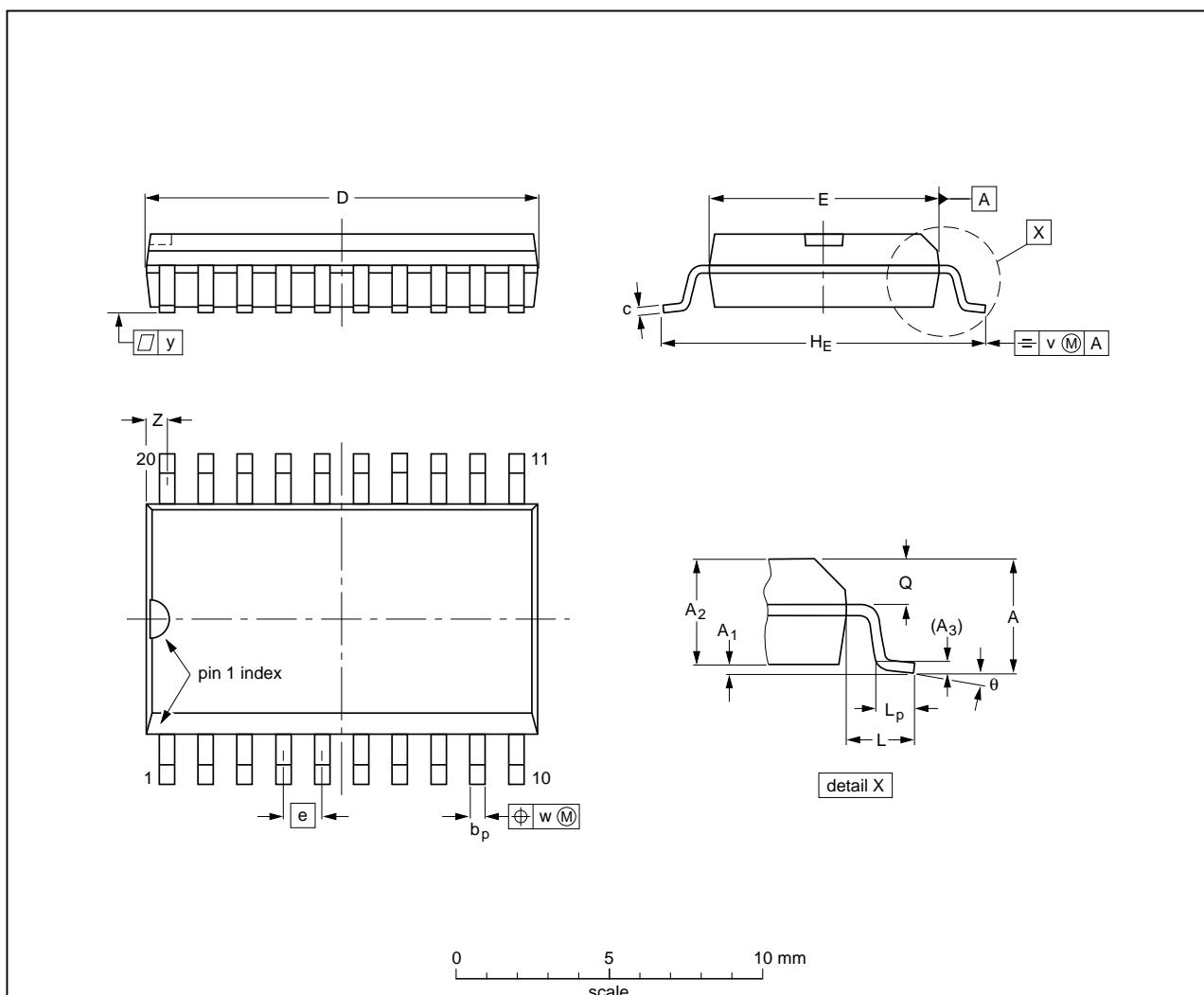
**Table 9. Test data**

Input				Load		$V_{EXT}$			
$V_I$	$f_i$	$t_W$	$t_r, t_f$	$C_L$	$R_L$	$t_{PHZ}, t_{PZH}$	$t_{PLZ}, t_{PZL}$	$t_{PLH}, t_{PHL}$	
2.7 V	$\leq 10$ MHz	500 ns	$\leq 2.5$ ns	50 pF	500 $\Omega$	GND	6 V	open	

## 12. Package outline

SO20: plastic small outline package; 20 leads; body width 7.5 mm

SOT163-1



### DIMENSIONS (inch dimensions are derived from the original mm dimensions)

UNIT	A max.	A <sub>1</sub>	A <sub>2</sub>	A <sub>3</sub>	b <sub>p</sub>	c	D <sup>(1)</sup>	E <sup>(1)</sup>	e	H <sub>E</sub>	L	L <sub>p</sub>	Q	v	w	y	z <sup>(1)</sup>	θ
mm	2.65 0.1	0.3 2.25	2.45	0.25	0.49 0.36	0.32 0.23	13.0 12.6	7.6 7.4	1.27	10.65 10.00	1.4	1.1 0.4	1.1 1.0	0.25	0.25	0.1	0.9 0.4	8°
inches	0.1	0.012 0.004	0.096 0.089	0.01	0.019 0.014	0.013 0.009	0.51 0.49	0.30 0.29	0.05	0.419 0.394	0.055	0.043 0.016	0.043 0.039	0.01	0.01	0.004	0.035 0.016	0°

### Note

1. Plastic or metal protrusions of 0.15 mm (0.006 inch) maximum per side are not included.

OUTLINE VERSION	REFERENCES				EUROPEAN PROJECTION	ISSUE DATE
	IEC	JEDEC	JEITA			
SOT163-1	075E04	MS-013				99-12-27 03-02-19

Fig 8. Package outline SOT163-1 (SO20)

TSSOP20: plastic thin shrink small outline package; 20 leads; body width 4.4 mm

SOT360-1

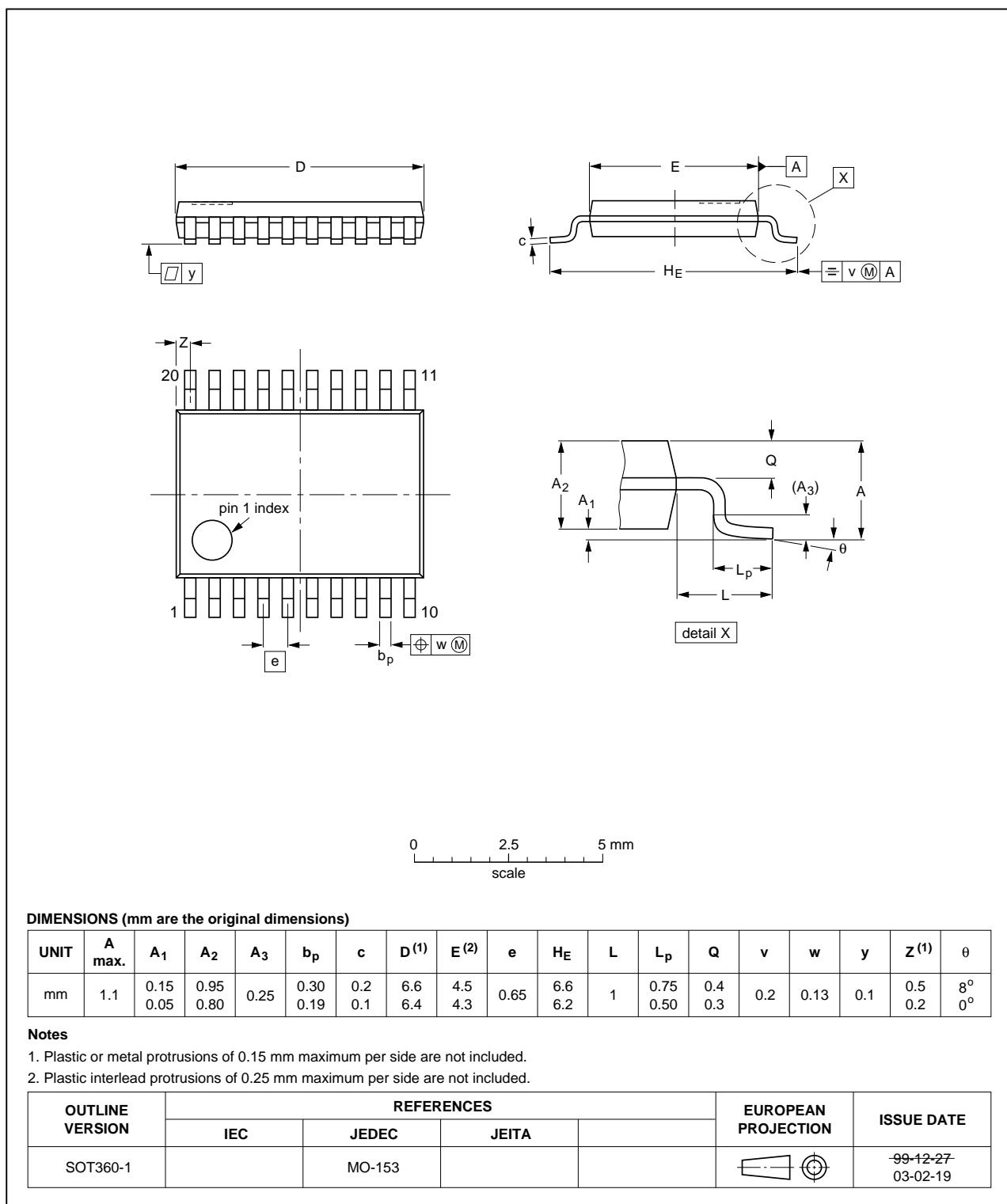


Fig 9. Package outline SOT360-1 (TSSOP20)

DHVQFN20: plastic dual in-line compatible thermal enhanced very thin quad flat package; no leads;  
20 terminals; body 2.5 x 4.5 x 0.85 mm

SOT764-1

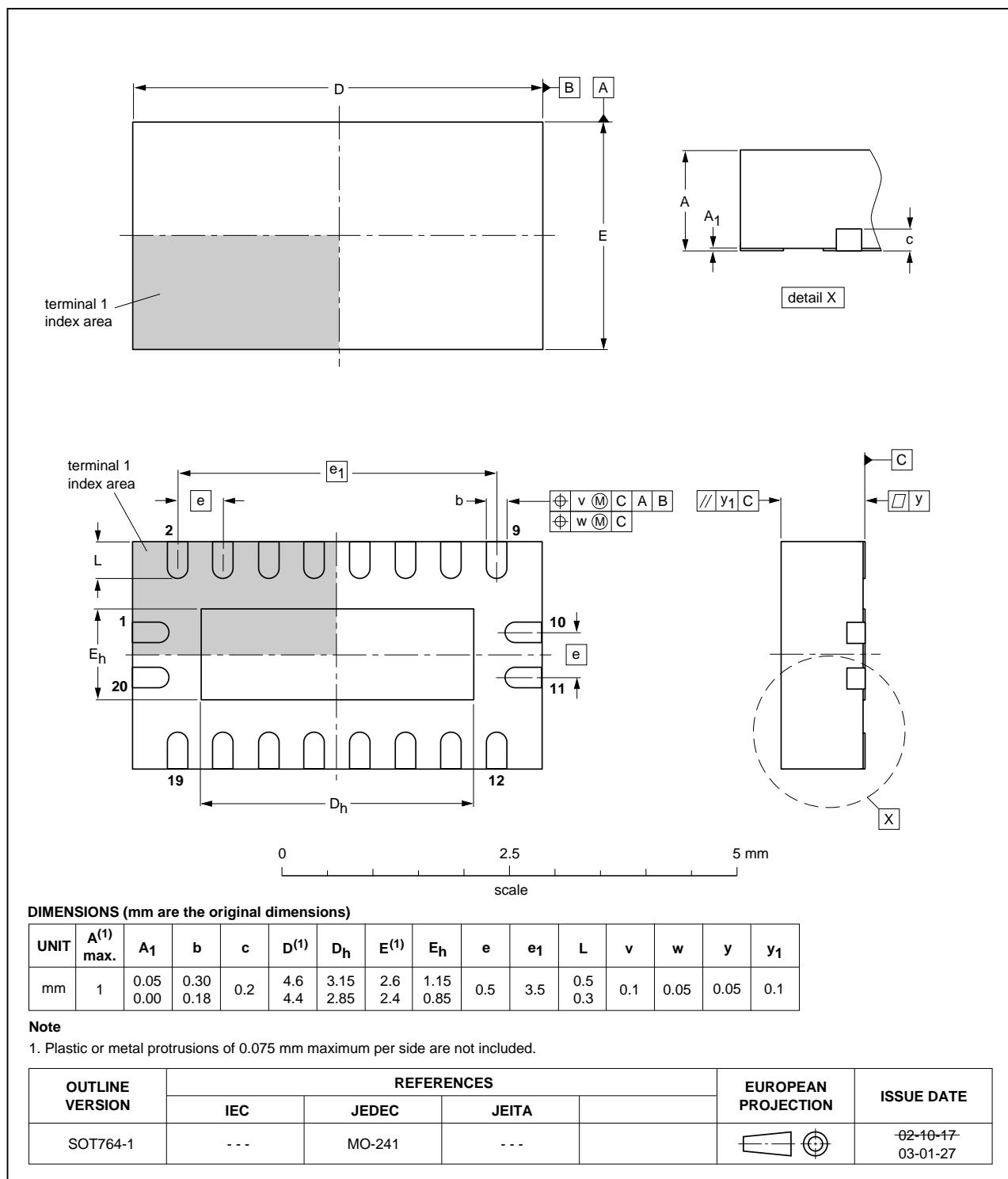


Fig 10. Package outline SOT764-1 (DHVQFN20)

## 13. Abbreviations

**Table 10. Abbreviations**

Acronym	Description
BiCMOS	Bipolar Complementary Metal Oxide Semiconductor
DUT	Device Under Test
ESD	ElectroStatic Discharge
HBM	Human Body Model
MM	Machine Model
MIL	Military
TTL	Transistor-Transistor Logic

## 14. Revision history

**Table 11. Revision history**

Document ID	Release date	Data sheet status	Change notice	Supersedes
74LVT_LVTH244A_Q100 v.1	20130422	Product data sheet	-	-

## 15. Legal information

### 15.1 Data sheet status

Document status <sup>[1][2]</sup>	Product status <sup>[3]</sup>	Definition
Objective [short] data sheet	Development	This document contains data from the objective specification for product development.
Preliminary [short] data sheet	Qualification	This document contains data from the preliminary specification.
Product [short] data sheet	Production	This document contains the product specification.

[1] Please consult the most recently issued document before initiating or completing a design.

[2] The term 'short data sheet' is explained in section "Definitions".

[3] The product status of device(s) described in this document may have changed since this document was published and may differ in case of multiple devices. The latest product status information is available on the Internet at URL <http://www.nexperia.com>.

### 15.2 Definitions

**Draft** — The document is a draft version only. The content is still under internal review and subject to formal approval, which may result in modifications or additions. Nexperia does not give any representations or warranties as to the accuracy or completeness of information included herein and shall have no liability for the consequences of use of such information.

**Short data sheet** — A short data sheet is an extract from a full data sheet with the same product type number(s) and title. A short data sheet is intended for quick reference only and should not be relied upon to contain detailed and full information. For detailed and full information see the relevant full data sheet, which is available on request via the local Nexperia sales office. In case of any inconsistency or conflict with the short data sheet, the full data sheet shall prevail.

**Product specification** — The information and data provided in a Product data sheet shall define the specification of the product as agreed between Nexperia and its customer, unless Nexperia and customer have explicitly agreed otherwise in writing. In no event however, shall an agreement be valid in which the Nexperia product is deemed to offer functions and qualities beyond those described in the Product data sheet.

**Suitability for use in automotive applications** — This Nexperia product has been qualified for use in automotive applications. Unless otherwise agreed in writing, the product is not designed, authorized or warranted to be suitable for use in life support, life-critical or safety-critical systems or equipment, nor in applications where failure or malfunction of a Nexperia product can reasonably be expected to result in personal injury, death or severe property or environmental damage. Nexperia and its suppliers accept no liability for inclusion and/or use of Nexperia products in such equipment or applications and therefore such inclusion and/or use is at the customer's own risk.

**Applications** — Applications that are described herein for any of these products are for illustrative purposes only. Nexperia makes no representation or warranty that such applications will be suitable for the specified use without further testing or modification.

Customers are responsible for the design and operation of their applications and products using Nexperia products, and Nexperia accepts no liability for any assistance with applications or customer product design. It is customer's sole responsibility to determine whether the Nexperia product is suitable and fit for the customer's applications and products planned, as well as for the planned application and use of customer's third party customer(s). Customers should provide appropriate design and operating safeguards to minimize the risks associated with their applications and products.

Nexperia does not accept any liability related to any default, damage, costs or problem which is based on any weakness or default in the customer's applications or products, or the application or use by customer's third party customer(s). Customer is responsible for doing all necessary testing for the customer's applications and products using Nexperia products in order to avoid a default of the applications and the products or of the application or use by customer's third party customer(s). Nexperia does not accept any liability in this respect.

**Limiting values** — Stress above one or more limiting values (as defined in the Absolute Maximum Ratings System of IEC 60134) will cause permanent damage to the device. Limiting values are stress ratings only and (proper) operation of the device at these or any other conditions above those given in the Recommended operating conditions section (if present) or the Characteristics sections of this document is not warranted. Constant or repeated exposure to limiting values will permanently and irreversibly affect the quality and reliability of the device.

**Terms and conditions of commercial sale** — Nexperia products are sold subject to the general terms and conditions of commercial sale, as published at <http://www.nexperia.com/profile/terms>, unless otherwise agreed in a valid written individual agreement. In case an individual agreement is concluded only the terms and conditions of the respective agreement shall apply. Nexperia hereby expressly objects to applying the customer's general terms and conditions with regard to the purchase of Nexperia products by customer.

### 15.3 Disclaimers

**Limited warranty and liability** — Information in this document is believed to be accurate and reliable. However, Nexperia does not give any representations or warranties, expressed or implied, as to the accuracy or completeness of such information and shall have no liability for the consequences of use of such information. Nexperia takes no responsibility for the content in this document if provided by an information source outside of Nexperia.

In no event shall Nexperia be liable for any indirect, incidental, punitive, special or consequential damages (including - without limitation - lost profits, lost savings, business interruption, costs related to the removal or replacement of any products or rework charges) whether or not such damages are based on tort (including negligence), warranty, breach of contract or any other legal theory.

Notwithstanding any damages that customer might incur for any reason whatsoever, Nexperia's aggregate and cumulative liability towards customer for the products described herein shall be limited in accordance with the *Terms and conditions of commercial sale* of Nexperia.

**Right to make changes** — Nexperia reserves the right to make changes to information published in this document, including without limitation specifications and product descriptions, at any time and without notice. This document supersedes and replaces all information supplied prior to the publication hereof.

**No offer to sell or license** — Nothing in this document may be interpreted or construed as an offer to sell products that is open for acceptance or the grant, conveyance or implication of any license under any copyrights, patents or other industrial or intellectual property rights.

**Export control** — This document as well as the item(s) described herein may be subject to export control regulations. Export might require a prior authorization from competent authorities.

**Translations** — A non-English (translated) version of a document is for reference only. The English version shall prevail in case of any discrepancy between the translated and English versions.

## 15.4 Trademarks

Notice: All referenced brands, product names, service names and trademarks are the property of their respective owners.

## 16. Contact information

For more information, please visit: <http://www.nexperia.com>

For sales office addresses, please send an email to: [salesaddresses@nexperia.com](mailto:salesaddresses@nexperia.com)

## 17. Contents

---

<b>1</b>	<b>General description</b> .....	<b>1</b>
<b>2</b>	<b>Features and benefits</b> .....	<b>1</b>
<b>3</b>	<b>Ordering information</b> .....	<b>2</b>
<b>4</b>	<b>Functional diagram</b> .....	<b>2</b>
<b>5</b>	<b>Pinning information</b> .....	<b>3</b>
5.1	Pinning .....	3
5.2	Pin description .....	3
<b>6</b>	<b>Functional description</b> .....	<b>4</b>
6.1	Function table .....	4
<b>7</b>	<b>Limiting values</b> .....	<b>4</b>
<b>8</b>	<b>Recommended operating conditions</b> .....	<b>4</b>
<b>9</b>	<b>Static characteristics</b> .....	<b>5</b>
<b>10</b>	<b>Dynamic characteristics</b> .....	<b>6</b>
<b>11</b>	<b>Waveforms</b> .....	<b>7</b>
<b>12</b>	<b>Package outline</b> .....	<b>9</b>
<b>13</b>	<b>Abbreviations</b> .....	<b>12</b>
<b>14</b>	<b>Revision history</b> .....	<b>12</b>
<b>15</b>	<b>Legal information</b> .....	<b>13</b>
15.1	Data sheet status .....	13
15.2	Definitions.....	13
15.3	Disclaimers.....	13
15.4	Trademarks.....	14
<b>16</b>	<b>Contact information</b> .....	<b>14</b>
<b>17</b>	<b>Contents</b> .....	<b>15</b>